

Ultrafast Rectifiers, Surface Mount, 6 A, 200 V - 600 V FES6, NRVFES6 Series

Features

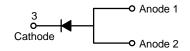
- Very Low Profile: Typical Height of 1.1 mm
- Ultrafast Recovery Time
- Low Forward Voltage Drop
- Low Thermal Resistance
- Very Stable Operation at Industrial Temperature, 150°C
- RoHS Compliant
- Green Molding Compound as per IEC61249 Standard
- Lead Free in Compliance with EU RoHS 2011/65/EU Directive
- With DAP Option Only
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

MAXIMUM RATINGS

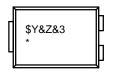
Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage FES6D FES6G FES6J	V_{RRM}	200 400 600	V
Average Forward Rectified Current	I _{F(AV)}	6	Α
Peak Forward Surge Current: 8.3 ms Single Half Sine–Wave Superimposed on Rated Load	I _{FSM}	80	Α
Operating Junction Temperature Range	T_J	–55 to +175	°C
Storage Temperature Range	T _{STG}	–55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

TO-277-3LD CASE 340BQ



MARKING DIAGRAM



\$Y

&3

- &Z
- = Assembly Plant Code

= onsemi Logo

- = Date Code (Year & Week)
- = Specific Device Code FES6D, FES6G, FES6J

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
FES6D	FES6D		
FES6G	FES6G	1	
NRVFES6G*	FESOG	TO-277 3L (with DAP Option only)	5000 / Tape & Reel
FES6J	FFCCI		
NRVFES6J*	FES6J		

DISCONTINUED (Note 1)

, ,			
NRVFES6D*	FES6D	TO-277 3L (with DAP Option only)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP

^{1.} DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on www.onsemi.com.

FES6, NRVFES6 Series

THERMAL CHARACTERISTICS (Values are at $T_A = 25$ °C unless otherwise noted) (Note 2)

Parameter	Symbol	Value	Unit
Thermal Characteristics, Junction-to-Lead, Thermocouple Soldered to Cathode	$\Psi_{\sf JL}$	6	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	100	°C/W

^{2.} Per JESD51-3 Recommended Thermal Test Board.

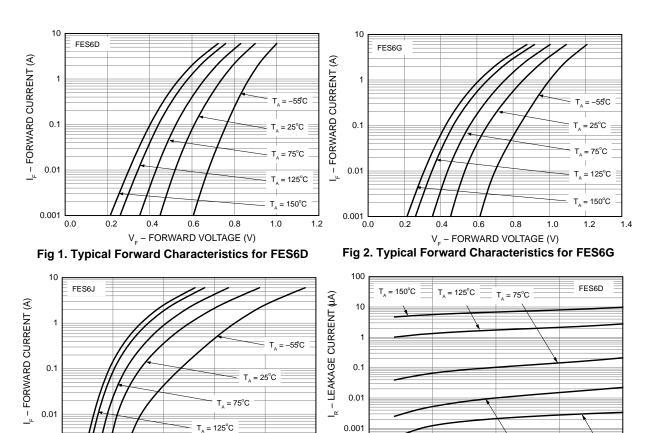
ELECTRICAL CHARACTERISTICS (Values are at $T_A = 25$ °C unless otherwise noted)

			Value			
Symbol	Parameter	Conditions	FES6D	FES6G	FES6J	Unit
V _F	Maximum Instantaneous Forward	I _F = 6 A	1.05	1.20	2.2	V
	Voltage (Note 3)	I _F = 6 A, T _J = 125°C	0.90	1.00	1.80	
I _R	Maximum Reverse Current	T _J = 25°C		2	•	μΑ
	at Rated V _R	T _J = 125°C	200	50	00	
CJ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	60 45		pF	
T _{rr}	Typical Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A	25 45		ns	
		$I_F = 1 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s}, \text{ V}_R = 30 \text{ V}$				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse test with PW = $300 \mu s$, 1% duty cycle

FES6, NRVFES6 Series

TYPICAL CHARACTERISTICS



1E-

2.5

Fig 3. Typical Forward Characteristics for FES6J

V_F - FORWARD VOLTAGE (V)

1.0

1.5

0.001

0.0

0.5

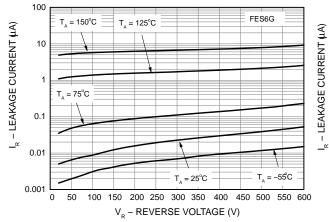


Fig 5. Typical Reverse Characteristics for FES6G

100 T_A = 150°C T_A = 125°C FES6J 10 11 T_A = 75°C 0.001 0.001 0 50 100 150 200 250 300 350 400 450 500 550 600 V_P - REVERSE VOLTAGE (V)

100

V_D - REVERSE VOLTAGE (V)

Fig 4. Typical Reverse Characteristics for FES6D

 $T_A = -55^{\circ}C$

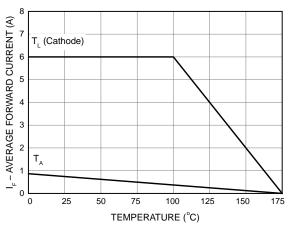
200

150

Fig 6. Typical Reverse Characteristics for FES6J

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TYPICAL CHARACTERISTICS





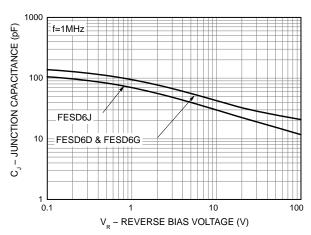
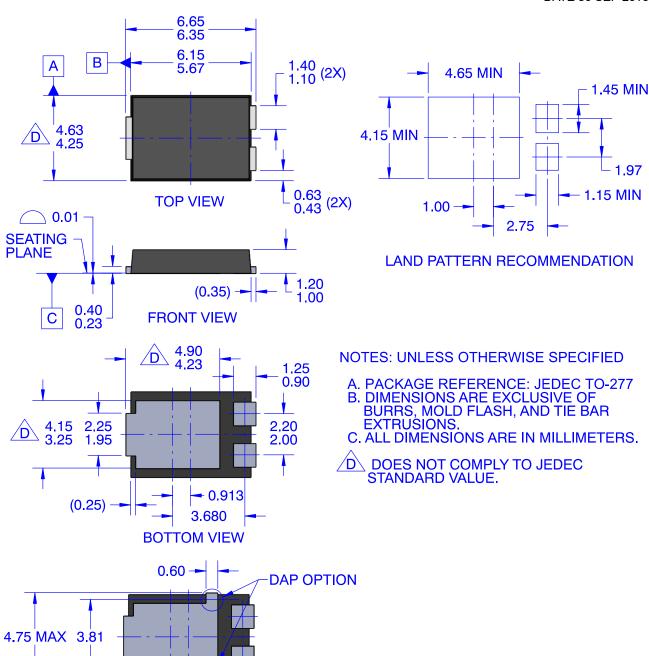


Fig 8. Typical Junction Capacitance

TO-277-3LD CASE 340BQ ISSUE O

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BOTTOM VIEW - DAP OPTION

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